

Annex B2 - Product environmental attributes Servers/Data Storage Products

The declaration may be published only when all rows and/or fields marked with * are filled-in (N/A for not applicable). Additional information regarding each item may be found under P15.

Brand *	Lenovo	Logo				
Company name *	Lenovo					
Contact information *	Lenovo Global Environmental Affairs		Lenovo			
e-mail address	Alvin L Carter					
	alcarter@lenovo.com					
Internet site *	https://www.lenovo.com/us/en/about/sustainability					
Additional information	The latest version of this document can be found at:					
	http://www.lenovo.com/ecodeclaration					

The company declares (based on product specification or test results based obtained from sample testing), that the product					
conforms to the statement	nts given in this declaration.				
Type of product *	Server				
Commercial name *	Lenovo ThinkSystem SR860				
Model number *	7X69, 7X70				
Issue date *	Jan 31, 2020				
Intended market *	🗌 Global 📃 Europe 🗌 Asia, Pacific & Japan 🗌 Americas 🔀 Other <i>China, EMEA, North</i>				
	America				
Additional information					

This is an uncontrolled copy when in printed form. Please refer to the contact information for the latest version.

About Annex B2

Annex B2 reflects Product environmental attributes relevant for Computers and Computer Monitors. The following items from the ECMA-370 Main body are not shown in the template:

P4.1 – P4.3 Consumable materials

P9.1 TEC and Print speed

P10.2 - P10.3 Chemical emissions from printing products

P11.1 - P11.3 Consumable materials for printing products.

mouorm	umber *	7X69, 7X70 Logo	Len			
lssue da	ite *	Jan 31, 2020				
Produc	t environ	mental attributes - Legal requirements	Require	ment	met	
Item			Yes	No	N/A	
P1	Hazardo	ous substances and preparations				
P1.1*	Product	s do comply with current European RoHS Directive. (See legal reference and NOTE B1)	\boxtimes			
P1.2*		s do not contain Asbestos (see legal reference). nt: Legal reference has no maximum concentration value.	\square			
P1.3*	hydrobro trichloro	s do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), omofluorocarbons (HBFC), hydrochlorofluorcarbons (HCFC), Halons, carbontetrachloride, 1,1,1- ethane, methyl bromide (see legal reference). Comment: Legal reference has no maximum ration values.				
P1.4*		s do not contain more than; 0,005% polychlorinated biphenyl (PCB), 0,005% polychlorinated /l (PCT) in preparations (see legal reference).	\boxtimes			
P1.5*	Product	s do not contain more than 0,1% short chain chloroparaffins (SCCP) with 10-13 carbon atoms in th ntaining at least 48% per mass of chlorine in the SCCP (see legal reference).	e 🔀			
P1.6*	(see leg	th direct and prolonged skin contact do not release nickel in concentrations above 0,5 μg/cm²/weel al reference). nt: Max limit in legal reference when tested according to EN1811:2011-5.	k 🗌		\square	
P1.7*	REACH	Article 33 information about substances in articles is available at (add URL or mail contact): ww.lenovo.com/us/en/sustainability-resources	\boxtimes			
P2	Batterie	s				
P2.1*		oduct contains a battery or an accumulator, the battery/accumulator is labeled with the disposal Information on proper disposal is provided in user manual. (See legal reference)	\boxtimes			
P2.2*	Batterie	s or accumulators do not contain more than 0,0005% of mercury or 0,002% of cadmium. (See lega e)	l 🛛			
P2.3*	Batterie	s and accumulators are readily removable. (See legal reference)	\boxtimes			
P2.4*	Docume	ntation includes the number of cycles the (secondary) battery can withstand. (See legal reference)) []			
P2.5*		ternal batteries of a notebook computer cannot be "accessed and replaced by a nonprofessional e related text is present and legible on the external packaging (see legal reference)				
P3		nity verification & Eco design (ErP)				
P3.1*		duct is CE-marked to show conformance with applicable legal requirements (see legal reference). claration of Conformity can be requested at: https://www.lenovo.com/us/en/compliance/eu-doc	\boxtimes			
P3.2*		duct complies with the Eco design requirements for energy-related products, al reference).	\boxtimes			
	Require	d information is; given in item P15 or added to this document, available at: https://www.lenovo.com/us/en/compliance/eco-declaration	\square			
P5	Product	packaging				
P5.1*	Packagi	ng and packaging components do not contain more than 0,01% lead, mercury, cadmium ar ent chromium by weight of these together.	nd 🔀			
P5.2*	The pac	kaging materials are marked with abbreviations and numbers indicating the nature of the material(se legal reference).	s) 🔀			
P5.3*	The prod (see leg	Juct packaging material is free from ozone depleting substances as specified in the Montreal Protoc al reference). nt: Legal reference has no maximum concentration values.	ol 🔀			
		and the forest sector and the sector of the				
P6	Treatme	Int information				

NOTE B1 Restriction applies to the homogeneous material, unless other specified and expressed in weight %. Stating "Yes" means that the product is compliant with the mandatory requirements.

Model number *		7X69, 7X70 Logo	>			
Issue date *		Jan 31, 2020		-eno		D _{TM}
Product		mental attributes - Market requirements (See General NOTE GN belo				
		nmental conscious design	R	equirer		
Item		tory to fill in. Additional information regarding each item may be found under P14.		Yes	No	N/A
P7.1*		Disassembly, recycling t have to be treated separately are easily separable				
P7.2*		aterials in covers/housing have no surface coating.			+	╞
P7.3*		arts > 100 g consist of one material or of easily separable materials.			╞	╞
P7.4*		arts > 25 g have material codes according to ISO 11469 referring ISO 1043-4.			⊢⊢	<u> </u>
P7.5			la taola		<u> </u>	<u> </u>
		arts are free from metal inlays or have inlays that can be removed with commonly availab			<u> </u>	<u> </u>
P7.6*		re easily separable. (This requirement does not apply to safety/regulatory labels).				
P7.7*	Product	g can be done e.g. with processor, memory, cards or drives				
P7.8*		ig can be done using commonly available tools			+	╞
P7.9		arts are available after end of production for: years				<u> </u>
						<u> </u>
P7.10		s available after end of production for: years				
P7.11*		and substance requirements cover/housing material type (e.g. plastics, metal, aluminum):				
1 7.11		type: Steel Material type (0.9. plastice, metal, administry). Material type: PC+ABS Material type	:			
P7.12		n materials of external electrical cables are PVC free.			\boxtimes	
P7.13	Insulation	n materials of internal electrical cables are PVC free.		Ē		Ē
P7.14		plastic casing/cover parts > 25 g contain no more than 0,1% weight (1000 ppm) bromine 1000 ppm) chlorine attributable to brominated flame retardants, chlorinated flame retar				
	polyvinyl	chloride or 0,3% weight (3000 ppm) bromine and 0,3% weight (3000 ppm) chlorine in parts n 25% post-consumer recycled content.				
P7.15		ircuit boards, PCBs (without components) are low halogen: all $$ PCBs > 25 g $$ are low din IEC 61249-2-21. (See ⁵ NOTE B2)	w halogen	\boxtimes		
P7.16		tarded plastic parts > 25 g in covers / housings are marked according ISO 1043-4:				
P7.17	<u>Alt. 1: </u> Ch	nemical specifications of flame retardants in printed circuit boards > 25 g (without compor	ents):			
	TBBPA (additive) 🛄, TBBPA (reactive) 📃 (See NOTE B3), Other: chemical name:, CAS #:				
	Alt. 2: Ch	nemical specifications of flame retardants in printed circuit boards (without components) >	25 g			
		g ISO 1043-4:	-			
P7.18	<u>Alt. 1: </u> Fl	ame retarded plastic parts > 25 g contain the following flame retardant substances/prep	arations in			
		ations above 0,1%:				
		ical name: , CAS #: (See NOTE B4) ical name: , CAS #: "				
		ical name: , CAS #: "				
	<u>Alt. 2: </u> Ch	nemical specifications of flame retardants in plastic parts > 25 g according ISO 1043-4:				
P7.19	In plastic	parts > 25 g, flame retardant substances/preparations above 0,1% are used which have	been		Ħ	Ħ
	•	the following Risk phrases; and Hazard statements:				
	The sour	ce(s) for these classifications is/are found at (add URL(s)):	te B5)			
P7.20*	Postcons	sumer recycled plastic material content is used in the product (See Note B6):			\boxtimes	
	a) Of t a pe or	t least one of the two alternatives below shall be answered; otal plastic parts' weight > 25 g, the postconsumer recycled plastic material content (calc ercentage of total plastic by weight) is %.	ulated as			
L		weight of recycled material is g.				

GENERAL NOTE Standard references should direct to the latest version of a standard. If an older version of a standard is used, section P15 shall be used for explanation.

NOTE B2 IEC 61249-2-21 defines maximum limits of 900 ppm for each of the substances chlorine and bromine and a maximum limit of 1500ppm of these substances combined. The standard does not address fluorine, iodine and astatine which are included in the group of halogens.

NOTE B3 and B4 A Guidance document on Chemical substances is available; see <u>http://www.ecma-international.org/publications/standards/Ecma-370.htm</u>.

NOTE B5 If a certain substance has been assigned a certain risk phrases / hazard statement in the referenced source, this does not necessarily mean the substance has been tested for all of the hazards referred to by a certain customer.

NOTE B6 Applies to a product containing plastic parts whose combined weight exceeds 100 g with the exception of printed circuit boards, cables, connectors and electronic components and bio-based plastic material.

Model number *	7X69, 7X60	Logo	
Issue date *	Jan 31, 2020		LEIIOVO

Product environmental attributes - Market requirements (continued)

Item

Requirement metYesNoN/A

	Material and substance requirements (continued)								
P7.21*		material content is used		TE B7):					
	 If YES; at least one of the two alternatives below shall be answered; a) Of total plastic parts' weight > 25 g, the biobased plastic material content (calculated as a percentage of total plastic by weight) is %. or b) The weight of the biobased plastic material is g. 								
P7.22*	/ -	•							
P1.22	Light sources are free from mercury, i.e. less than 0,1 mg/lamp.								
P7.23*		es an integral display, the							
P8	Batteries		-						
P8.1*	Battery chemical	composition: Lithium N	langanese Dioxide						
P9		ption (See NOTE B8)							
P9.1		he following power level	s or energy consumption	ns are reported:					
Energy mod		Power level at	Power level at	Power level at	Reference/Standard for energy				
		100 V AC	115 V AC	230 V AC	modes and test method *				
Peak (On-r	nax)	W	W	W	Full load				
Category	/								
EPS No-loa	ad	W	W	W					
· ·	ower supply /								
	gged in the wall								
the product	isconnected from								
PTEC *	•)	W	W	W					
	ergy Consumption								
ETEC *		kWh/year	kWh/year	kWh/year	\boxtimes				
	ergy Consumption								
		ency Level (International	Efficiency Marking Prot	ocol) * :					
Display res		negapixels							
Default time	e to enter energy	save mode: 25 minutes							
P9.2*	Information about	t the energy save function	on is provided with the p	roduct.					
P9.3	Energy efficiency	<pre>v class (monitors only):</pre>							
P10	Emissions	- Declared according to	150 9296 (See NOTE	B9)					
P10.1	Mode	Mode description			t A-weighted sound power level, <i>L</i> _{WA,c} (B)				
	Idle	* idle mode		* 6.1					
	Operation	* CPU stress 50%		* 6.1					
	Other mode	Declared A-weighted sound		(operator pos	sition desktop – idle)				
	Other mode Declared A-weighted sound pressure level (dB) L_{pAm}								
	Measured accord	ding to: 🔀 ISO 7779 🗌 Other	ECMA-74 (only if not covered by I	=CMA_74)					
	Electromagneti								
P10.4		y meets the requirement	for low frequency elect	romagnetic fields of th	e following voluntary				
C	P. = 3. =								

NOTE B7 The following is to be excluded from the calculation of percentage: printed circuit boards, labels, cables, connectors and electronic components and postconsumer recycled plastic

NOTE B8 A Guidance document on Energy Efficiency is available;

see http://www.ecma-international.org/publications/standards/Ecma-370.htm NOTE B9 A Guidance document on Acoustic Noise is available;

see http://www.ecma-international.org/publications/standards/Ecma-370.htm

Model nu	mber *	7X69, 7X60				Logo			
Issue date *		Jan 31, 2020				-	Leno	VO	тм
Product	environ	nental attribu	tes - Market requiremen	ts (continued)		•	Require	ment	met
ltem							Yes	No	N/A
P12		mics for compu							
P12.1*	The disp	lay meets the er	gonomic requirements of ISC	O 9241-307 for visua	al display technolo	ogies.	\square		
P12.2*	The phy	sical input device	e meets the requirements of	ISO 9995 and ISO 9	9241-410.		\boxtimes		
P13	Packagi	ng and docum	entation						
P13.1*	Product	packaging mate	rial type(s): Corrugated boa rial type(s): EPE (Expand ap rial type(s): Wooden		weight (kg): 6.00 weight (kg): 2.52 weight (kg): 8.04	20			
P13.2*			ackaging is free from PVC.		0 (0)		\boxtimes		
P13.3*		luct primary cor	rugated fiberboard packagir er content: 55 %	ng, specify the cont	ained percentage	e of minimum			
P13.4*		media for user a ronic, ⊠Paper,	nd product documentation (ti	ck box):					
P13.5	Ùser an	<i>,</i> ,	is item if paper documentation entation on paper media is c	,					
	Totally c	hlorine-free					\boxtimes		
	Element	al chlorine-free							
	Process	ed chlorine-free							
P14	Volunta	ry programs							
P14.1	The proc	duct meets the re	equirements of the following	voluntary program(s):				
	ENERG	Y STAR®	Criteria version:	Date:	Product	category:			
	Eco-labe		Criteria version:	Date:		category:			
	Eco-labe		Criteria version:	Date:	Product	category:			
P15			(See NOTE B10)						
P9			f computer products; desc						
	the info supplie informa Accoun	rmation contaiı r's knowledge a tion. The inforn t Representativ	no representations, guara ned in this document. All in wailable at the time of com nation provided here is app re for more information.	formation provide pletion, and suppl proximate and prov	d by supplier in t ier shall have no rided for informa	his docume obligation to	nt is provided o update such	based	don
P9	See Ene https://\	ergy Star Qualif www.energysta	ied Enterprise Servers for t r.gov/products/data_center	the latest informati equipment/enter	on: orise servers				

NOTE B10 Additional lines may be inserted to declare further items, by positioning the cursor at the far right of the row and hitting the <Enter> key.

Legal references Europe Annex B2

Reference	Declaration item
Directive 2011/65/EU (RoHS Directive)* * Specific exemptions apply for certain products and applications.	P1.1, P3.1
Regulation (EC) 1907/2006 (REACH Regulation), annex XVII	P1.2, P1.4, P1.6, P1.7
Regulation (EC) 2037/2000, 2038/2000, 2039/2000 (Marketing and use of Ozone layer depleting substances)	P1.3, P5.3
Norwegian regulation relating to restrictions on the use of certain dangerous chemicals 20.12.2002	P1.5
Directive 2006/66/EC (Battery and accumulators Directive), as amended.* * These provisions shall not apply where, for safety, performance, medical or data integrity reasons, continuity of power supply is necessary and requires a permanent connection between the appliance and the battery or accumulator.	P2.1, P2.2, P2,3, P8.1
Directive 2014/35/EU (Low Voltage Directive)	P3.1
Directive 2014/30/EU (EMC Directive)	P3.1
Directive 2014/53/EU (RE Directive)	P3.1
Regulation (EC) 801/2013 amending Regulation (EC) No 1275/2008 with regard to ecodesign requirements for standby, off mode electric power consumption of electrical and electronic household and office equipment, and amending Regulation (EC) No 642/2009 with regard to ecodesign requirements for televisions	P3.1, P3.2
Commission Regulation (EC) No 278/2009 of 6 April 2009 implementing Directive 2005/32/EC of the European Parliament and of the Council with regard to ecodesign requirements for no-load condition electric power demand and average active efficiency of external power supplies	P3.1, P3.2, P9.1
COMMISSION REGULATION (EU) No 617/2013 of 26 June 2013 implementing Directive 2009/125/EC of the European Parliament and of the Council with regard to ecodesign requirements for computers and computer servers	P2.4, P2.5, P3.1, P3.2, P7.23, P9.1
Regulation (EC) No 1272/2008 (CLP Regulation)	P7.19
Directive 2004/12/EC (Packaging Directive)	P5.1
Decision 97/129/EC (Secondary packaging legislation)	P5.2
Directive 2012/19/EU (WEEE directive)	P6.1
Implementing Regulation (EU) 2019/290 establishing the format for registration and reporting of producers of electrical and electronic equipment to the register.	
Commission Implementing Regulation 2017/699 establishing a common methodology for the calculation of the weight of electrical and electronic equipment (EEE) placed on the national market in each Member State and a common methodology for the calculation of the quantity of waste electrical and electronic equipment (WEEE) generated by weight in each Member State.	

Lenovo ErP Lot9 Information Sheet - Servers & Storage Products-

As required by COMMISSION REGULATION (EU) 2019/424 of 15 March 2019 laying down ecodesign requirements for servers and data storage products pursuant to Directive 2009/125/EC of the European Parliament and of the Council and amending Commission Regulation (EU) No 617/2013. (ErP Lot9)

Products scope of this sheet: Servers & storage products

This document is only valid in connection with the IT Eco Declaration of the specific Product.

SERVERS

General information

Commercial name (3.1 (b))	Lenovo ThinkSystem SR860	Logo	
Contact Address (3.1 (b))	7001 Development Dr. Building 7,Morrisville, NC 27560, United		
	States		Lenovo
Model Number (3.1 (c))	7X69, 7X70		Lenovo.
Issue Date	Jan 31, 2020		
Additional information	The latest version of this document can be found at: http://www.lenovo.com/ecodeclaration		

Product environmental attributes (EU) 2019/424 – Annex II points 3.1 and 3.3
1.a Is the product consider to be in scope of ErP Lot 9 in scope out of scope, product is out of scope as:
1.b Server type Rack Server High Performance Computing (HPC) (3.1 (a)) Tower Server Multi Node Server Blade Server Data Storage product (Please go to "DATA STORAGE PRODUCTS" section
1.c Year of manufacture: 2017 (3.1 (d)) 2017 2017
1.d Product model part of a server product family? No X Yes (3.1 (p)) List of all model configurations that are represented by the model: http://psref.lenovo.com/Product/ThinkSystem/ThinkSystem_SR860
1.e Information on the secure data deletion functionality (3.1 (n))
 (a) instructions on how to use the functionality: 2 methods are provided to use the functionality. 1) Use a command line tool to do the secure data deletion on the remote target system via boot up a customized Linux OS on it. Eg: OneCli.exe serase -bmc USERID:PASSWORD@xx.xx.xxsftp root:password@xx.xxx.xx./home - log 5 2) Use BoMC to create a full functions bootable media, start the media and choose secure erase from the text menu. (b) techniques used: OS tools under Linux -> Standard Linux Open Source tool (c) supported secure data deletion standard (if any): Secure Erase/block Erase/Crypto Erase, Sanitize OR - Reference to other information: Hdparm: https://www.mankier.com/1/nvme-format sg_sanitize: https://www.systutorials.com/docs/linux/man/8-sg_sanitize/ scrub: https://www.systutorials.com/docs/linux/man/1-scrub/
storcli: https://docs.broadcom.com/docs-and-downloads/raid-controllers/raid-controllers-common-iles/StorCLI RefMan revf.pdf
1.f Blade servers? No Yes (3.1 (o)) list of recommended combinations with compatible chassis:
Recycling Data
2.a Indicative weight range at component level, of the (3.3 (a)) (a) Cobalt in the batteries (b) Neodymium in the HDDs (3.3 (a)) following critical raw materials: (a) Cobalt in the batteries (b) Neodymium in the HDDs (a) between 5 g and 25 g between 5 g and 25 g between 5 g and 25 g
2.b Instructions on the disassembly operations (3.3 (b)) (a) the type of operation; (b) the type and number of fastening technique(s) to be unlocked; (c) the tool(s) required. OR - Reference to other information: https://datacentersupport.lenovo.com/us/en/
2.c Firmware Reference to information on last available firmware: https://datacentersupport.lenovo.com/us/en/products/servers/thinksystem/sr860/downloads/driver-list/
Additional information

Server family specific information Family 1

Family	no. / name	1 - 2 CPU populate	ed fami	lv		
Model n (3.1 (c))	del number(s) / Description Standard or low-end performance configuration: Processor(Minimum result of core count *					
Additio	nal information	You can refer to https://www.plugloads				l.aspx?id=49&type=1 along with 860 for the PSU efficiency details.
Produc	ct environmental attri				_	
F1.a (3.1 (e))	(expressed in % and Standard or low-end		mal plac	d 100 % of rated output power ce): Multi-output Single Average 93.92%	e-outp	ut
	High-end performand			-		
F1.b		of the rated load level	, 33.33	standard or low-end performa	nce	high-end performance
(3.1 (f))	(rounded to three de	cimal places)		configuration: 0.990		configuration: 0.990
F1.c (3.1 (g))	PSU rated power out (in Watts rounded to			standard or low-end performation configuration: 750W	nce	high-end performance configuration: 750W
	internal note: If a product model is part of a ser product family shall be reported y	ver product family, all PSUs offered in a rith the information specified in (e) and (server			
F1.d (3.1 (h)) F1.e	idle state power (in Watts and rounde	d to the first decimal places for additional idle powe	ce)	standard or low-end performatic configuration: 87.7W	nce	high-end performance configuration: 96.1W
(3.1 (i))	CPU Performance	star con	ndard or figuratio	low-end performance	confi	-end performance guration: 1 Socket
(0				et (7 × PerfCPU W)	$\boxtimes 2$	2 Socket
ents	Additional PSU		(Yes / No			(Yes / No) #: 1
stm	HDD		(Yes / I			(Yes / No) #: 2
u[ju	SDD Additional memory	No	1	No) #: No) #: 92GB	No	(Yes / No) #: (Yes / No) #: 380GB
es a sting	Additional buffered DDF			No) #: 4 channel		(Yes / No) #: 3000B (Yes / No) #: 4 channel
idle power allowances adjustments during testing	Additional I/O devices		none < 1 Gb/s: = 1 Gb/s : > 1 Gb/s a ≥ 10 Gb/s ≥ 25 Gb/s	No Allowance 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port and < 25Gb/s: 15,0 W/Active Port and < 50Gb/s: 20,0 W/Active Port 26,0 W/Active Port		one 1 Gb/s: No Allowance 1 Gb/s: 2,0 W/Active Port 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port 10 Gb/s and < 25Gb/s: 15,0 W/Active Port 25 Gb/s and < 50Gb/s: 20,0 W/Active Port 50 Gb/s 26,0 W/Active Port
F1.f	maximum power			standard or low-end performa	nce	high-end performance
(3.1 (j)) F1.g (3.1 (k))	(in Watts and rounde operating condition o (as defined in Table (ce)	configuration: 189.5 standard or low-end performan configuration: □ A1 ○ A2 □ A3 □ A4 Exception comments	nce	configuration: 682.1 high-end performance configuration: A1 A2 A3 A4 Exception comments
F1.h (3.1 (l))	of the declared opera	e higher boundary tempe ating condition class (in V	Vatts)	standard or low-end performan configuration: 92.1		high-end performance configuration: 100.9
F1.i (3.1 (m))	the active state effici- active state of the se	ency and the performanc rver;	e in	standard or low-end performatic configuration: 13.6	nce	high-end performance configuration: 34.4

Server family specific information Family 2

Family	no. / name	2 - 4 CPU p	opulated fam	ilv						
Model n	number(s) / Description			ance configuration: N/A						
(3.1 (c))		High-end perform								
		You can refer to								
Additio	nal information				Detail.aspx?id=49&type=1 along with					
					m_SR860 for the PSU efficiency details.					
Produc	ct environmental attri	butes (EU) 2019/4	124 – Annex I	I points 3.1 and 3.3						
F1.a	.a PSU efficiency at 10 % (if applicable), 20 %, 50 % and 100 % of rated output power									
(3.1 (e))	(expressed in % and	rounded to the firs	t decimal plac	ce): 🔲 Multi-output 🛛 🔀 Singl	e-output					
	Standard or low-end	performance config	guration(s):							
	10% 92.30 20% 9 4	.63 50% 95.22	100% 93.08	Average 94.31%						
	high-end performance									
	10% 92.30 20% 9 4									
F1.b	Power factor at 50 %		evel	standard or low-end performan						
(3.1 (f))	(rounded to three de			configuration: 1.0	configuration: 1.0					
F1.c	PSU rated power out			standard or low-end performan						
(3.1 (g))	(in Watts rounded to	the nearest integer	r)	configuration: 2000W	configuration: 2000W					
	internal note:		General in a second							
	If a product model is part of a ser product family shall be reported v	ver product ramity, all PSUs of vith the information specified in	n (e) and (f)							
F1.d	idle state power			standard or low-end performation						
(3.1 (h))	(in Watts and rounde			configuration:	configuration:					
F1.e	List of all component	ts for additional idle	e power allow	ances						
(3.1 (i))			atondard a	low and norfermance	high and norfermance					
			standard or low-end performance configuration:		high-end performance configuration:					
	CPU Performance									
	CFU Fenomiance		1 Socket (10 × PerfCPU W)		1 Socket					
Ś			2 Socket (7 × PerfCPU W)		2 Socket					
ent	Additional PSU			(No) #:	(Yes / No) #:					
ţ	HDD			/ No) #:	(Yes / No) #:					
djus	SDD			'No) #:	(Yes / No) #:					
s a(ing	Additional memory			'No) #:	(Yes / No) #:					
iest	Additional buffered DDF	R channel	(Yes /	' No) #:	(Yes / No) #:					
var ng t	Additional I/O devices		none		none					
furi			< 1 Gb/s:	No Allowance	< 1 Gb/s: No Allowance					
ere			= 1 Gb/s;	2,0 W/Active Port	= 1 Gb/s: 2,0 W/Active Port					
power allowances adjustments during testing				and < 10 Gb/s: 4,0 W/Active Port	> 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port					
idle p				and < 25Gb/s: 15,0 W/Active Port						
ē					\geq 10 Gb/s and < 25Gb/s: 15,0 W/Active Port					
				and < 50Gb/s: 20,0 W/Active Port	≥ 25 Gb/s and < 50Gb/s: 20,0 W/Active Port					
			≥ 50 Gb/s	26,0 W/Active Port	≥ 50 Gb/s 26,0 W/Active Port					
F1.f	maximum power			standard or low-end performan	o ,					
(3.1 (j))	(in Watts and rounde		al place)	configuration:	configuration:					
F1.g	operating condition of			standard or low-end performan						
(3.1 (k))	(as defined in Table	o or ErP lot 9)		configuration:	configuration:					
				A1 A2 A3 A4	A1 A2 A3 A4					
				Exception converses	Europetics and the					
				Exception comments	Exception comments					
	tella atata anno 1900	a biahaa barra (bi	1 t	standard an law and a first	non kink and andarate					
F1.h	idle state power at th			standard or low-end performan	0 1					
(3.1 (l))	of the declared operative state offici			configuration:	configuration:					
F1.i (3.1 (m))	the active state effici		mance in	standard or low-end performan						
(0.1 (111))	active state of the se	ivel,		configuration:	configuration:					